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#### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

#### Applications of "[Embedded - Microcontrollers](#)"

##### Details

Product Status	Discontinued at Digi-Key
Core Processor	RL78
Core Size	16-Bit
Speed	32MHz
Connectivity	CSI, I <sup>2</sup> C, LINbus, UART/USART
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	34
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	1.6V ~ 5.5V
Data Converters	A/D 10x8/10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LFQFP (7x7)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f104gcfb-x0">https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f104gcfb-x0</a>

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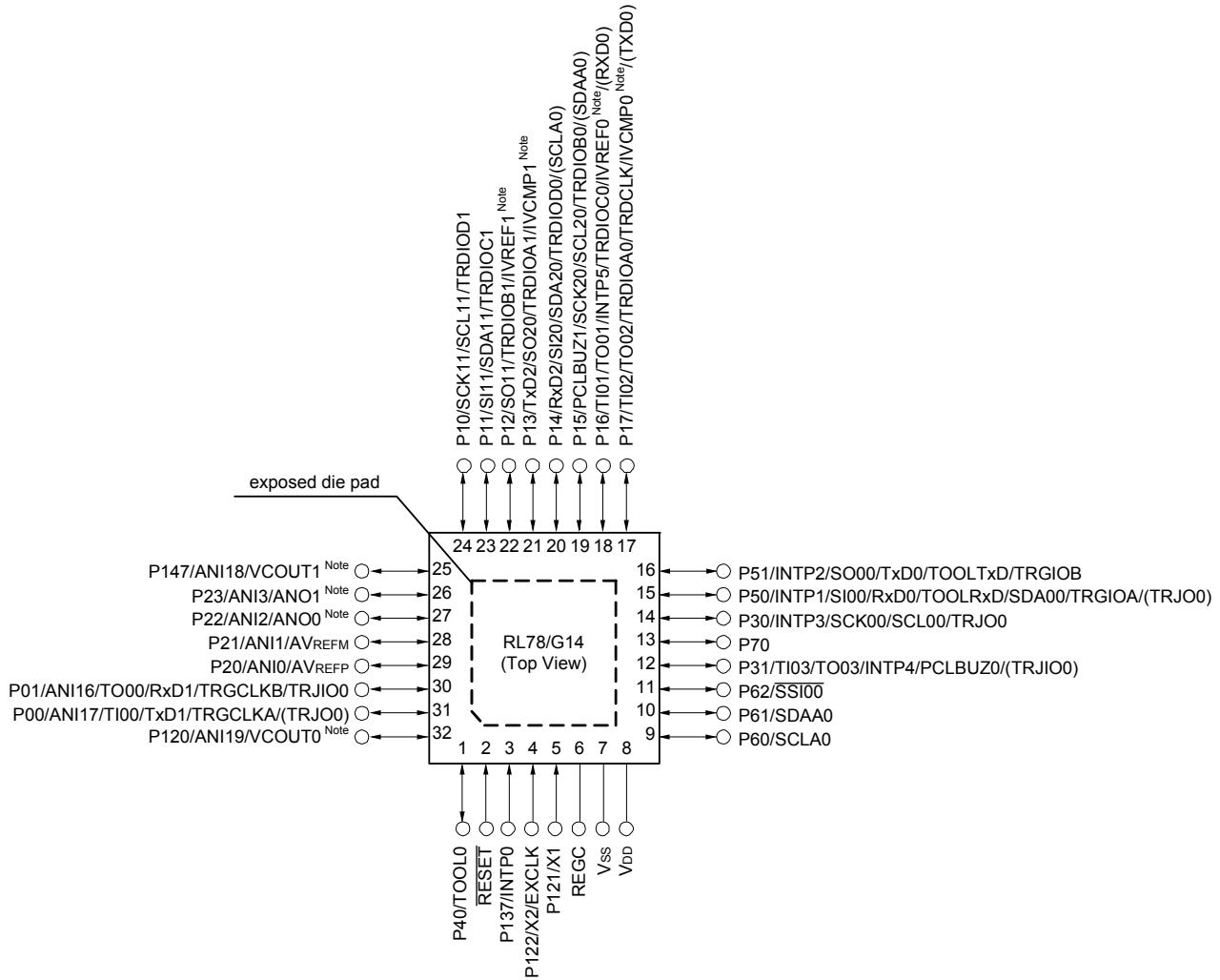
Pin count	Package	Fields of Application Note	Ordering Part Number
30 pins	30-pin plastic LSSOP (7.62 mm (300), 0.65 mm pitch)	A	R5F104AAASP#V0, R5F104ACASP#V0, R5F104ADASP#V0, R5F104AEASP#V0, R5F104AFASP#V0, R5F104AGASP#V0  R5F104AAASP#X0, R5F104ACASP#X0, R5F104ADASP#X0, R5F104AEASP#X0, R5F104AFASP#X0, R5F104AGASP#X0
		D	R5F104AADSP#V0, R5F104ACDSP#V0, R5F104ADDSP#V0, R5F104AEDSP#V0, R5F104AFDSP#V0, R5F104AGDSP#V0  R5F104AADSP#X0, R5F104ACDSP#X0, R5F104ADDSP#X0, R5F104AEDSP#X0, R5F104AFDSP#X0, R5F104AGDSP#X0
		G	R5F104AAGSP#V0, R5F104ACGSP#V0, R5F104ADGSP#V0, R5F104AEGSP#V0, R5F104AFGSP#V0, R5F104AGGSP#V0  R5F104AAGSP#X0, R5F104ACGSP#X0, R5F104ADGSP#X0, R5F104AEGSP#X0, R5F104AFGSP#X0, R5F104AGGSP#X0
32 pins	32-pin plastic HWQFN (5 × 5 mm, 0.5 mm pitch)	A	R5F104BAANA#U0, R5F104BCANA#U0, R5F104BDANA#U0, R5F104BEANA#U0, R5F104BFANA#U0, R5F104BGANA#U0  R5F104BAANA#W0, R5F104BCANA#W0, R5F104BDANA#W0, R5F104BEANA#W0, R5F104BFANA#W0, R5F104BGANA#W0
		D	R5F104BADNA#U0, R5F104BCDNA#U0, R5F104BDDNA#U0, R5F104BEDNA#U0, R5F104BFDNA#U0, R5F104BGDNA#U0  R5F104BADNA#W0, R5F104BCDNA#W0, R5F104BDDNA#W0, R5F104BEDNA#W0, R5F104BFDNA#W0, R5F104BGDNA#W0
		G	R5F104BAGNA#U0, R5F104BCGNA#U0, R5F104BDGNA#U0, R5F104BEGNA#U0, R5F104BFGNA#U0, R5F104BGGNA#U0  R5F104BAGNA#W0, R5F104BCGNA#W0, R5F104BDGNA#W0, R5F104BEGNA#W0, R5F104BFGNA#W0, R5F104BGGNA#W0
32 pins	32-pin plastic LQFP (7 × 7, 0.8 mm pitch)	A	R5F104BAAFP#V0, R5F104BCAFTP#V0, R5F104BDAFP#V0, R5F104BEAFTP#V0, R5F104BFAFP#V0, R5F104BGAFP#V0  R5F104BAAFP#X0, R5F104BCAFTP#X0, R5F104BDAFP#X0, R5F104BEAFTP#X0, R5F104BFAFP#X0, R5F104BGAFP#X0
		D	R5F104BADFP#V0, R5F104BCDFP#V0, R5F104BDDFP#V0, R5F104BEDFP#V0, R5F104BFDFP#V0, R5F104BGDFP#V0  R5F104BADFP#X0, R5F104BCDFP#X0, R5F104BDDFP#X0, R5F104BEDFP#X0, R5F104BFDFP#X0, R5F104BGDFP#X0
		G	R5F104BAGFP#V0, R5F104BCGFP#V0, R5F104BDGFP#V0, R5F104BEGFP#V0, R5F104BFGFP#V0, R5F104BGGFP#V0  R5F104BAGFP#X0, R5F104BCGFP#X0, R5F104BDGFP#X0, R5F104BEGFP#X0, R5F104BFGFP#X0, R5F104BGGFP#X0
36 pins	36-pin plastic WFLGA (4 × 4 mm, 0.5 mm pitch)	A	R5F104CAALA#U0, R5F104CCALA#U0, R5F104CDALA#U0, R5F104CEALA#U0, R5F104CFALA#U0, R5F104CGALA#U0  R5F104CAALA#W0, R5F104CCALA#W0, R5F104CDALA#W0, R5F104CEALA#W0, R5F104CFALA#W0, R5F104CGALA#W0
		G	R5F104CAGLA#U0, R5F104CCGLA#U0, R5F104CDGLA#U0, R5F104CEGLA#U0, R5F104CFGGLA#U0, R5F104CGGLA#U0  R5F104CAGLA#W0, R5F104CCGLA#W0, R5F104CDGLA#W0, R5F104CEGLA#W0, R5F104CFGGLA#W0, R5F104CGGLA#W0

**Note** For the fields of application, refer to **Figure 1 - 1 Part Number, Memory Size, and Package of RL78/G14**.

**Caution** The ordering part numbers represent the numbers at the time of publication. For the latest ordering part numbers, refer to the target product page of the Renesas Electronics website.

### 1.3.2 32-pin products

- 32-pin plastic HWQFN (5 × 5 mm, 0.5 mm pitch)



**Note** Mounted on the 96 KB or more code flash memory products.

**Caution** Connect the REGC pin to Vss pin via a capacitor (0.47 to 1  $\mu$ F).

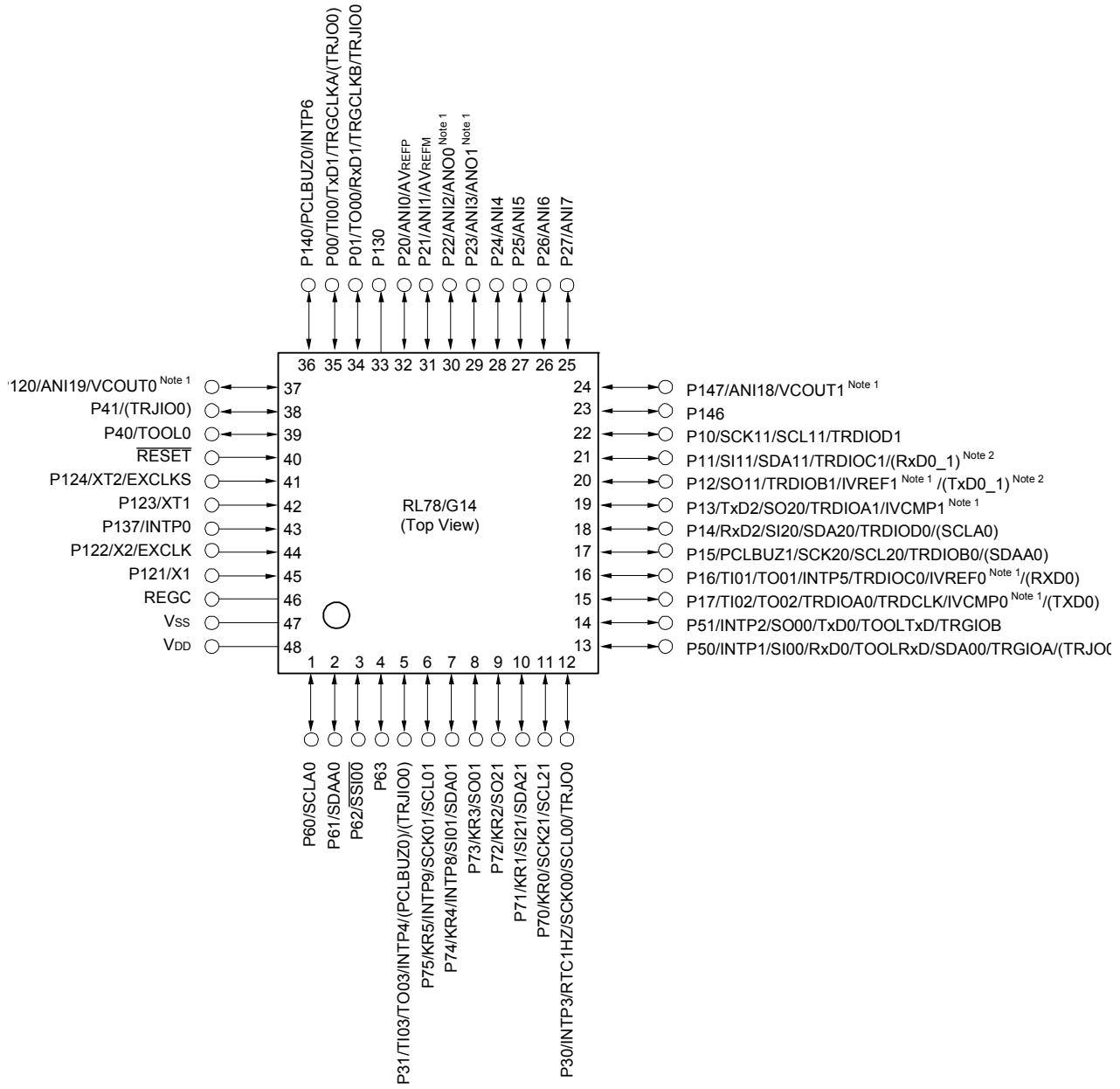
**Remark 1.** For pin identification, see [1.4 Pin Identification](#).

**Remark 2.** Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register 0, 1 (PIOR0, 1).

**Remark 3.** It is recommended to connect an exposed die pad to Vss.

### 1.3.6 48-pin products

- 48-pin plastic LFQFP (7 × 7 mm, 0.5 mm pitch)



**Note 1.** Mounted on the 96 KB or more code flash memory products.

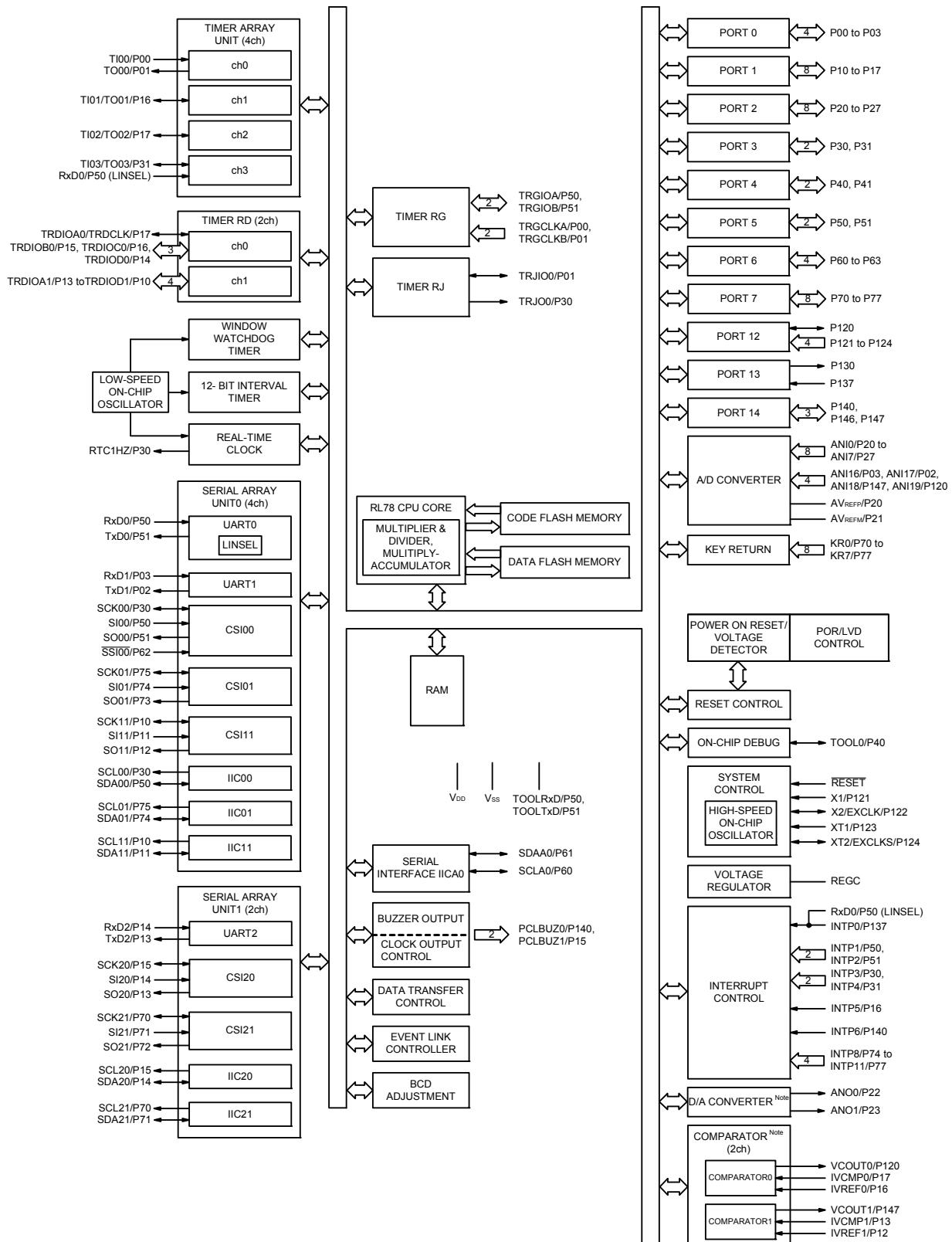
**Note 2.** Mounted on the 384 KB or more code flash memory products.

**Caution** Connect the REGC pin to Vss pin via a capacitor (0.47 to 1  $\mu$ F).

**Remark 1.** For pin identification, see 1.4 Pin Identification.

**Remark 2.** Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register 0, 1 (PIOR0, 1).

### 1.5.7 52-pin products



**Note** Mounted on the 96 KB or more code flash memory products.

## 1.6 Outline of Functions

[30-pin, 32-pin, 36-pin, 40-pin products (code flash memory 16 KB to 64 KB)]

**Caution This outline describes the functions at the time when Peripheral I/O redirection register 0, 1 (PIOR0, 1) are set to 00H.**

(1/2)

Item		30-pin	32-pin	36-pin	40-pin
		R5F104Ax (x = A, C to E)	R5F104Bx (x = A, C to E)	R5F104Cx (x = A, C to E)	R5F104Ex (x = A, C to E)
Code flash memory (KB)		16 to 64	16 to 64	16 to 64	16 to 64
Data flash memory (KB)		4	4	4	4
RAM (KB)		2.5 to 5.5 Note	2.5 to 5.5 Note	2.5 to 5.5 Note	2.5 to 5.5 Note
Address space		1 MB			
Main system clock	High-speed system clock	X1 (crystal/ceramic) oscillation, external main system clock input (EXCLK) HS (high-speed main) mode: 1 to 20 MHz ( $V_{DD}$ = 2.7 to 5.5 V), HS (high-speed main) mode: 1 to 16 MHz ( $V_{DD}$ = 2.4 to 5.5 V), LS (low-speed main) mode: 1 to 8 MHz ( $V_{DD}$ = 1.8 to 5.5 V), LV (low-voltage main) mode: 1 to 4 MHz ( $V_{DD}$ = 1.6 to 5.5 V)			
	High-speed on-chip oscillator clock ( $f_{IH}$ )	HS (high-speed main) mode: 1 to 32 MHz ( $V_{DD}$ = 2.7 to 5.5 V), HS (high-speed main) mode: 1 to 16 MHz ( $V_{DD}$ = 2.4 to 5.5 V), LS (low-speed main) mode: 1 to 8 MHz ( $V_{DD}$ = 1.8 to 5.5 V), LV (low-voltage main) mode: 1 to 4 MHz ( $V_{DD}$ = 1.6 to 5.5 V)			
Subsystem clock		—			XT1 (crystal) oscillation, external subsystem clock input (EXCLKS) 32.768 kHz
Low-speed on-chip oscillator clock		15 kHz (TYP.): $V_{DD}$ = 1.6 to 5.5 V			
General-purpose register		8 bits $\times$ 32 registers (8 bits $\times$ 8 registers $\times$ 4 banks)			
Minimum instruction execution time		0.03125 $\mu$ s (High-speed on-chip oscillator clock: $f_{IH}$ = 32 MHz operation)			
		0.05 $\mu$ s (High-speed system clock: $f_{MX}$ = 20 MHz operation)			
		—			30.5 $\mu$ s (Subsystem clock: $f_{SUB}$ = 32.768 kHz operation)
Instruction set		<ul style="list-style-type: none"> <li>• Data transfer (8/16 bits)</li> <li>• Adder and subtractor/logical operation (8/16 bits)</li> <li>• Multiplication (8 bits <math>\times</math> 8 bits, 16 bits <math>\times</math> 16 bits), Division (16 bits <math>\div</math> 16 bits, 32 bits <math>\div</math> 32 bits)</li> <li>• Multiplication and Accumulation (16 bits <math>\times</math> 16 bits + 32 bits)</li> <li>• Rotate, barrel shift, and bit manipulation (Set, reset, test, and Boolean operation), etc.</li> </ul>			
I/O port	Total	26	28	32	36
	CMOS I/O	21	22	26	28
	CMOS input	3	3	3	5
	CMOS output	—	—	—	—
	N-ch open-drain I/O (6 V tolerance)	2	3	3	3
Timer	16-bit timer	8 channels (TAU: 4 channels, Timer RJ: 1 channel, Timer RD: 2 channels, Timer RG: 1 channel)			
	Watchdog timer	1 channel			
	Real-time clock (RTC)	1 channel			
	12-bit interval timer	1 channel			
	Timer output	Timer outputs: 13 channels PWM outputs: 9 channels			
	RTC output	—			1 • 1 Hz (subsystem clock: $f_{SUB}$ = 32.768 kHz)

(Note is listed on the next page.)

- Note** The flash library uses RAM in self-programming and rewriting of the data flash memory.  
The target products and start address of the RAM areas used by the flash library are shown below.
- R5F104xD (x = A to C, E to G, J, L): Start address FE900H  
R5F104xE (x = A to C, E to G, J, L): Start address FE900H
- For the RAM areas used by the flash library, see **Self RAM list of Flash Self-Programming Library for RL78 Family (R20UT2944)**.

[44-pin, 48-pin, 52-pin, 64-pin products (code flash memory 16 KB to 64 KB)]

**Caution This outline describes the functions at the time when Peripheral I/O redirection register 0, 1 (PIOR0, 1) are set to 00H.**

(1/2)

Item	44-pin	48-pin	52-pin	64-pin
	R5F104Fx (x = A, C to E)	R5F104Gx (x = A, C to E)	R5F104Jx (x = C to E)	R5F104Lx (x = C to E)
Code flash memory (KB)	16 to 64	16 to 64	32 to 64	32 to 64
Data flash memory (KB)	4	4	4	4
RAM (KB)	2.5 to 5.5 Note	2.5 to 5.5 Note	4 to 5.5 Note	4 to 5.5 Note
Address space	1 MB			
Main system clock	High-speed system clock	X1 (crystal/ceramic) oscillation, external main system clock input (EXCLK) HS (high-speed main) mode: 1 to 20 MHz ( $V_{DD} = 2.7$ to 5.5 V), HS (high-speed main) mode: 1 to 16 MHz ( $V_{DD} = 2.4$ to 5.5 V), LS (low-speed main) mode: 1 to 8 MHz ( $V_{DD} = 1.8$ to 5.5 V), LV (low-voltage main) mode: 1 to 4 MHz ( $V_{DD} = 1.6$ to 5.5 V)		
	High-speed on-chip oscillator clock ( $f_{IH}$ )	HS (high-speed main) mode: 1 to 32 MHz ( $V_{DD} = 2.7$ to 5.5 V), HS (high-speed main) mode: 1 to 16 MHz ( $V_{DD} = 2.4$ to 5.5 V), LS (low-speed main) mode: 1 to 8 MHz ( $V_{DD} = 1.8$ to 5.5 V), LV (low-voltage main) mode: 1 to 4 MHz ( $V_{DD} = 1.6$ to 5.5 V)		
Subsystem clock		XT1 (crystal) oscillation, external subsystem clock input (EXCLKS) 32.768 kHz		
Low-speed on-chip oscillator clock		15 kHz (TYP.): $V_{DD} = 1.6$ to 5.5 V		
General-purpose register		8 bits × 32 registers (8 bits × 8 registers × 4 banks)		
Minimum instruction execution time		0.03125 µs (High-speed on-chip oscillator clock: $f_{IH} = 32$ MHz operation) 0.05 µs (High-speed system clock: $f_{MX} = 20$ MHz operation) 30.5 µs (Subsystem clock: $f_{SUB} = 32.768$ kHz operation)		
Instruction set		<ul style="list-style-type: none"> <li>• Data transfer (8/16 bits)</li> <li>• Adder and subtractor/logical operation (8/16 bits)</li> <li>• Multiplication (8 bits × 8 bits, 16 bits × 16 bits), Division (16 bits ÷ 16 bits, 32 bits ÷ 32 bits)</li> <li>• Multiplication and Accumulation (16 bits × 16 bits + 32 bits)</li> <li>• Rotate, barrel shift, and bit manipulation (Set, reset, test, and Boolean operation), etc.</li> </ul>		
I/O port	Total	40	44	48
	CMOS I/O	31	34	38
	CMOS input	5	5	5
	CMOS output	—	1	1
	N-ch open-drain I/O (6 V tolerance)	4	4	4
Timer	16-bit timer	8 channels (TAU: 4 channels, Timer RJ: 1 channel, Timer RD: 2 channels, Timer RG: 1 channel)		
	Watchdog timer	1 channel		
	Real-time clock (RTC)	1 channel		
	12-bit interval timer	1 channel		
	Timer output	Timer outputs: 13 channels PWM outputs: 9 channels		
	RTC output	1 • 1 Hz (subsystem clock: $f_{SUB} = 32.768$ kHz)		

(Note is listed on the next page.)

[80-pin, 100-pin products (code flash memory 96 KB to 256 KB)]

**Caution This outline describes the functions at the time when Peripheral I/O redirection register 0, 1 (PIOR0, 1) are set to 00H.**

(1/2)

Item	80-pin	100-pin	
	R5F104Mx (x = F to H, J)	R5F104Px (x = F to H, J)	
Code flash memory (KB)	96 to 256	96 to 256	
Data flash memory (KB)	8	8	
RAM (KB)	12 to 24 Note	12 to 24 Note	
Address space	1 MB		
Main system clock	High-speed system clock X1 (crystal/ceramic) oscillation, external main system clock input (EXCLK) HS (high-speed main) mode: 1 to 20 MHz ( $V_{DD} = 2.7$ to 5.5 V), HS (high-speed main) mode: 1 to 16 MHz ( $V_{DD} = 2.4$ to 5.5 V), LS (low-speed main) mode: 1 to 8 MHz ( $V_{DD} = 1.8$ to 5.5 V), LV (low-voltage main) mode: 1 to 4 MHz ( $V_{DD} = 1.6$ to 5.5 V)		
	High-speed on-chip oscillator clock ( $f_{IH}$ ) HS (high-speed main) mode: 1 to 32 MHz ( $V_{DD} = 2.7$ to 5.5 V), HS (high-speed main) mode: 1 to 16 MHz ( $V_{DD} = 2.4$ to 5.5 V), LS (low-speed main) mode: 1 to 8 MHz ( $V_{DD} = 1.8$ to 5.5 V), LV (low-voltage main) mode: 1 to 4 MHz ( $V_{DD} = 1.6$ to 5.5 V)		
Subsystem clock	XT1 (crystal) oscillation, external subsystem clock input (EXCLKS) 32.768 kHz		
Low-speed on-chip oscillator clock	15 kHz (TYP.): $V_{DD} = 1.6$ to 5.5 V		
General-purpose register	8 bits × 32 registers (8 bits × 8 registers × 4 banks)		
Minimum instruction execution time	0.03125 µs (High-speed on-chip oscillator clock: $f_{IH} = 32$ MHz operation) 0.05 µs (High-speed system clock: $f_{MX} = 20$ MHz operation) 30.5 µs (Subsystem clock: $f_{SUB} = 32.768$ kHz operation)		
Instruction set	<ul style="list-style-type: none"> <li>• Data transfer (8/16 bits)</li> <li>• Adder and subtractor/logical operation (8/16 bits)</li> <li>• Multiplication (8 bits × 8 bits, 16 bits × 16 bits), Division (16 bits ÷ 16 bits, 32 bits ÷ 32 bits)</li> <li>• Multiplication and Accumulation (16 bits × 16 bits + 32 bits)</li> <li>• Rotate, barrel shift, and bit manipulation (Set, reset, test, and Boolean operation), etc.</li> </ul>		
I/O port	Total CMOS I/O CMOS input CMOS output N-ch open-drain I/O (6 V tolerance)	74 64 5 1 4	92 82 5 1 4
Timer	16-bit timer Watchdog timer Real-time clock (RTC) 12-bit interval timer Timer output RTC output	12 channels (TAU: 8 channels, Timer RJ: 1 channel, Timer RD: 2 channels, Timer RG: 1 channel) 1 channel 1 channel 1 channel Timer outputs: 18 channels PWM outputs: 12 channels 1 • 1 Hz (subsystem clock: $f_{SUB} = 32.768$ kHz)	

**Note** In the case of the 24 KB, this is about 23 KB when the self-programming function and data flash function are used (For details, see **CHAPTER 3** in the RL78/G14 User's Manual).

(TA = -40 to +85°C, 1.6 V ≤ EV<sub>DD0</sub> = EV<sub>DD1</sub> ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>SS0</sub> = EV<sub>SS1</sub> = 0 V) (4/5)

Items	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Output voltage, high	V <sub>OH1</sub>	P00 to P06, P10 to P17, P30, P31, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P100 to P102, P110, P111, P120, P130, P140 to P147	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OH1</sub> = -10.0 mA	EV <sub>DD0</sub> - 1.5			V
			4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OH1</sub> = -3.0 mA	EV <sub>DD0</sub> - 0.7			V
			1.8 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OH1</sub> = -1.5 mA	EV <sub>DD0</sub> - 0.5			V
			1.6 V ≤ EV <sub>DD0</sub> < 1.8 V, I <sub>OH1</sub> = -1.0 mA	EV <sub>DD0</sub> - 0.5			V
	V <sub>OH2</sub>	P20 to P27, P150 to P156	1.6 V ≤ V <sub>DD</sub> ≤ 5.5 V, I <sub>OH2</sub> = -100 μA	V <sub>DD</sub> - 0.5			V
Output voltage, low	V <sub>OL1</sub>	P00 to P06, P10 to P17, P30, P31, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P100 to P102, P110, P111, P120, P130, P140 to P147	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OL1</sub> = 20.0 mA			1.3	V
			4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OL1</sub> = 8.5 mA			0.7	V
			2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OL1</sub> = 3.0 mA			0.6	V
			2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OL1</sub> = 1.5 mA			0.4	V
			1.8 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OL1</sub> = 0.6 mA			0.4	V
			1.6 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OL1</sub> = 0.3 mA			0.4	V
	V <sub>OL2</sub>	P20 to P27, P150 to P156	1.6 V ≤ V <sub>DD</sub> ≤ 5.5 V, I <sub>OL2</sub> = 400 μA			0.4	V
	V <sub>OL3</sub>	P60 to P63	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OL3</sub> = 15.0 mA			2.0	V
			4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OL3</sub> = 5.0 mA			0.4	V
			2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OL3</sub> = 3.0 mA			0.4	V
			1.8 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OL3</sub> = 2.0 mA			0.4	V
			1.6 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OL3</sub> = 1.0 mA			0.4	V

**Caution** P00, P02 to P04, P10, P11, P13 to P15, P17, P30, P43 to P45, P50 to P55, P71, P74, P80 to P82, P142 to P144 do not output high level in N-ch open-drain mode.

**Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

### 2.3.2 Supply current characteristics

#### (1) Flash ROM: 16 to 64 KB of 30- to 64-pin products

(TA = -40 to +85°C, 1.6 V ≤ EV<sub>D0</sub> ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>S0</sub> = 0 V)

Parameter	Symbol	Conditions					MIN.	TYP.	MAX.	Unit
Supply current Note 1	IDD1	Operating mode	HS (high-speed main mode Note 5	f <sub>HOCO</sub> = 64 MHz, f <sub>IH</sub> = 32 MHz Note 3	Basic operation	V <sub>DD</sub> = 5.0 V		2.4		mA
						V <sub>DD</sub> = 3.0 V		2.4		
		HS (high-speed main mode Note 5	f <sub>HOCO</sub> = 32 MHz, f <sub>IH</sub> = 32 MHz Note 3	Basic operation	V <sub>DD</sub> = 5.0 V		2.1			mA
						V <sub>DD</sub> = 3.0 V		2.1		
			f <sub>HOCO</sub> = 64 MHz, f <sub>IH</sub> = 32 MHz Note 3	Normal operation	V <sub>DD</sub> = 5.0 V		5.1	8.7		
						V <sub>DD</sub> = 3.0 V		5.1	8.7	
			f <sub>HOCO</sub> = 32 MHz, f <sub>IH</sub> = 32 MHz Note 3	Normal operation	V <sub>DD</sub> = 5.0 V		4.8	8.1		
						V <sub>DD</sub> = 3.0 V		4.8	8.1	
			f <sub>HOCO</sub> = 48 MHz, f <sub>IH</sub> = 24 MHz Note 3	Normal operation	V <sub>DD</sub> = 5.0 V		4.0	6.9		
						V <sub>DD</sub> = 3.0 V		4.0	6.9	
		f <sub>HOCO</sub> = 24 MHz, f <sub>IH</sub> = 24 MHz Note 3	Normal operation	V <sub>DD</sub> = 5.0 V			3.8	6.3		
					V <sub>DD</sub> = 3.0 V		3.8	6.3		
			f <sub>HOCO</sub> = 16 MHz, f <sub>IH</sub> = 16 MHz Note 3	Normal operation	V <sub>DD</sub> = 5.0 V		2.8	4.6		
						V <sub>DD</sub> = 3.0 V		2.8	4.6	
		LS (low-speed main mode Note 5	f <sub>HOCO</sub> = 8 MHz, f <sub>IH</sub> = 8 MHz Note 3	Normal operation	V <sub>DD</sub> = 3.0 V		1.3	2.0		mA
						V <sub>DD</sub> = 2.0 V		1.3	2.0	
		LV (low-voltage main mode Note 5	f <sub>HOCO</sub> = 4 MHz, f <sub>IH</sub> = 4 MHz Note 3	Normal operation	V <sub>DD</sub> = 3.0 V		1.3	1.8		mA
						V <sub>DD</sub> = 2.0 V		1.3	1.8	
		HS (high-speed main mode Note 5	f <sub>MX</sub> = 20 MHz Note 2, V <sub>DD</sub> = 5.0 V	Normal operation	Square wave input		3.3	5.3		mA
					Resonator connection		3.4	5.5		
			f <sub>MX</sub> = 20 MHz Note 2, V <sub>DD</sub> = 3.0 V	Normal operation	Square wave input		3.3	5.3		
					Resonator connection		3.4	5.5		
			f <sub>MX</sub> = 10 MHz Note 2, V <sub>DD</sub> = 5.0 V	Normal operation	Square wave input		2.0	3.1		
					Resonator connection		2.1	3.2		
			f <sub>MX</sub> = 10 MHz Note 2, V <sub>DD</sub> = 3.0 V	Normal operation	Square wave input		2.0	3.1		
					Resonator connection		2.1	3.2		
		LS (low-speed main mode Note 5	f <sub>MX</sub> = 8 MHz Note 2, V <sub>DD</sub> = 3.0 V	Normal operation	Square wave input		1.2	1.9		mA
					Resonator connection		1.2	2.0		
			f <sub>MX</sub> = 8 MHz Note 2, V <sub>DD</sub> = 2.0 V	Normal operation	Square wave input		1.2	1.9		
					Resonator connection		1.2	2.0		
		Subsystem clock operation	f <sub>SUB</sub> = 32.768 kHz Note 4 TA = -40°C	Normal operation	Square wave input		4.7	6.1		μA
					Resonator connection		4.7	6.1		
			f <sub>SUB</sub> = 32.768 kHz Note 4 TA = +25°C	Normal operation	Square wave input		4.7	6.1		
					Resonator connection		4.7	6.1		
			f <sub>SUB</sub> = 32.768 kHz Note 4 TA = +50°C	Normal operation	Square wave input		4.8	6.7		
					Resonator connection		4.8	6.7		
			f <sub>SUB</sub> = 32.768 kHz Note 4 TA = +70°C	Normal operation	Square wave input		4.8	7.5		
					Resonator connection		4.8	7.5		
			f <sub>SUB</sub> = 32.768 kHz Note 4 TA = +85°C	Normal operation	Square wave input		5.4	8.9		
					Resonator connection		5.4	8.9		

(Notes and Remarks are listed on the next page.)

**(1) Flash ROM: 16 to 64 KB of 30- to 64-pin products**

(TA = -40 to +85°C, 1.6 V ≤ EVDD0 ≤ VDD ≤ 5.5 V, Vss = EVSS0 = 0 V)(2/2)

Parameter	Symbol	Conditions				MIN.	TYP.	MAX.	Unit	
Supply current Note 1	IDD2 Note 2	HALT mode	HS (high-speed main) mode Note 7	fHO CO = 64 MHz, fIH = 32 MHz Note 4	VDD = 5.0 V		0.80	3.09	mA	
					VDD = 3.0 V		0.80	3.09		
				fHO CO = 32 MHz, fIH = 32 MHz Note 4	VDD = 5.0 V		0.49	2.40		
					VDD = 3.0 V		0.49	2.40		
				fHO CO = 48 MHz, fIH = 24 MHz Note 4	VDD = 5.0 V		0.62	2.40		
					VDD = 3.0 V		0.62	2.40		
				fHO CO = 24 MHz, fIH = 24 MHz Note 4	VDD = 5.0 V		0.4	1.83		
					VDD = 3.0 V		0.4	1.83		
				fHO CO = 16 MHz, fIH = 16 MHz Note 4	VDD = 5.0 V		0.37	1.38		
					VDD = 3.0 V		0.37	1.38		
			LS (low-speed main) mode Note 7	fHO CO = 8 MHz, fIH = 8 MHz Note 4	VDD = 3.0 V		260	710	μA	
					VDD = 2.0 V		260	710		
			LV (low-voltage main) mode Note 7	fHO CO = 4 MHz, fIH = 4 MHz Note 4	VDD = 3.0 V		420	700	μA	
					VDD = 2.0 V		420	700		
			HS (high-speed main) mode Note 7	fMX = 20 MHz Note 3, VDD = 5.0 V	Square wave input		0.28	1.55	mA	
					Resonator connection		0.40	1.74		
				fMX = 20 MHz Note 3, VDD = 3.0 V	Square wave input		0.28	1.55		
					Resonator connection		0.40	1.74		
				fMX = 10 MHz Note 3, VDD = 5.0 V	Square wave input		0.19	0.86		
					Resonator connection		0.25	0.93		
				fMX = 10 MHz Note 3, VDD = 3.0 V	Square wave input		0.19	0.86		
					Resonator connection		0.25	0.93		
			LS (low-speed main) mode Note 7	fMX = 8 MHz Note 3, VDD = 3.0 V	Square wave input		95	550	μA	
					Resonator connection		140	590		
				fMX = 8 MHz Note 3, VDD = 2.0 V	Square wave input		95	550		
					Resonator connection		140	590		
			Subsystem clock operation	fSUB = 32.768 kHz Note 5, TA = -40°C	Square wave input		0.25	0.57	μA	
					Resonator connection		0.44	0.76		
				fSUB = 32.768 kHz Note 5, TA = +25°C	Square wave input		0.30	0.57		
					Resonator connection		0.49	0.76		
				fSUB = 32.768 kHz Note 5, TA = +50°C	Square wave input		0.36	1.17		
					Resonator connection		0.59	1.36		
				fSUB = 32.768 kHz Note 5, TA = +70°C	Square wave input		0.49	1.97		
					Resonator connection		0.72	2.16		
				fSUB = 32.768 kHz Note 5, TA = +85°C	Square wave input		0.97	3.37		
					Resonator connection		1.16	3.56		
IDD3 Note 6	STOP mode Note 8	TA = -40°C					0.18	0.51	μA	
		TA = +25°C					0.24	0.51		
		TA = +50°C					0.29	1.10		
		TA = +70°C					0.41	1.90		
		TA = +85°C					0.90	3.30		

(Notes and Remarks are listed on the next page.)

(2) During communication at same potential (CSI mode) (master mode, SCKp... internal clock output, corresponding CSI00 only)

(TA = -40 to +85°C, 2.7 V ≤ EV<sub>DD0</sub> = EV<sub>DD1</sub> ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>VSS0</sub> = EV<sub>VSS1</sub> = 0 V)

Parameter	Symbol	Conditions		HS (high-speed main) mode		LS (low-speed main) mode		LV (low-voltage main) mode		Unit
				MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
SCKp cycle time	tkCY1	tkCY1 ≥ 2/fCLK	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	62.5		250		500		ns
			2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	83.3		250		500		ns
SCKp high-/low-level width	tkH1, tkL1	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	tkCY1/2 - 7		tkCY1/2 - 50		tkCY1/2 - 50		ns	
			2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	tkCY1/2 - 10		tkCY1/2 - 50		tkCY1/2 - 50		ns
Slp setup time (to SCKp↑) Note 1	tsIK1	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	23		110		110		ns	
			2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	33		110		110		ns
Slp hold time (from SCKp↑) Note 2	tksI1	2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	10		10		10		ns	
Delay time from SCKp↓ to SOp output Note 3	tkso1	C = 20 pF Note 4		10		10		10		ns

**Note 1.** When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The Slp setup time becomes “to SCKp↓” when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

**Note 2.** When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The Slp hold time becomes “from SCKp↓” when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

**Note 3.** When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The delay time to SOp output becomes “from SCKp↑” when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

**Note 4.** C is the load capacitance of the SCKp and SOp output lines.

**Caution** Select the normal input buffer for the Slp pin and the normal output mode for the SOp pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg).

**Remark 1.** This value is valid only when CSI00's peripheral I/O redirect function is not used.

**Remark 2.** p: CSI number (p = 00), m: Unit number (m = 0), n: Channel number (n = 0),  
g: PIM and POM numbers (g = 1)

**Remark 3.** fmck: Serial array unit operation clock frequency

(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number (mn = 00))

**(6) Communication at different potential (1.8 V, 2.5 V, 3 V) (UART mode)**(TA = -40 to +85°C, 1.6 V ≤ EV<sub>D0</sub> = EV<sub>D1</sub> ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>S0</sub> = EV<sub>S1</sub> = 0 V)

Parameter	Symbol	Conditions	HS (high-speed main) mode		LS (low-speed main) mode		LV (low-voltage main) mode		Unit
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
Transfer rate		reception	4.0 V ≤ EV <sub>D0</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V		f <sub>MCK</sub> /6 Note 1		f <sub>MCK</sub> /6 Note 1		f <sub>MCK</sub> /6 Note 1 bps
			Theoretical value of the maximum transfer rate f <sub>MCK</sub> = f <sub>CLK</sub> Note 4		5.3		1.3		0.6 Mbps
			2.7 V ≤ EV <sub>D0</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V		f <sub>MCK</sub> /6 Note 1		f <sub>MCK</sub> /6 Note 1		f <sub>MCK</sub> /6 Note 1 bps
			Theoretical value of the maximum transfer rate f <sub>MCK</sub> = f <sub>CLK</sub> Note 4		5.3		1.3		0.6 Mbps
			1.8 V ≤ EV <sub>D0</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V		f <sub>MCK</sub> /6 Notes 1, 2, 3		f <sub>MCK</sub> /6 Notes 1, 2		f <sub>MCK</sub> /6 Notes 1, 2 bps
			Theoretical value of the maximum transfer rate f <sub>MCK</sub> = f <sub>CLK</sub> Note 4		5.3		1.3		0.6 Mbps

**Note 1.** Transfer rate in the SNOOZE mode is 4800 bps only.

However, the SNOOZE mode cannot be used when FRQSEL4 = 1.

**Note 2.** Use it with EV<sub>D0</sub> ≥ V<sub>b</sub>.**Note 3.** The following conditions are required for low voltage interface when EV<sub>D0</sub> < V<sub>DD</sub>.2.4 V ≤ EV<sub>D0</sub> < 2.7 V: MAX. 2.6 Mbps1.8 V ≤ EV<sub>D0</sub> < 2.4 V: MAX. 1.3 Mbps**Note 4.** The maximum operating frequencies of the CPU/peripheral hardware clock (f<sub>CLK</sub>) are:HS (high-speed main) mode: 32 MHz (2.7 V ≤ V<sub>DD</sub> ≤ 5.5 V)16 MHz (2.4 V ≤ V<sub>DD</sub> ≤ 5.5 V)LS (low-speed main) mode: 8 MHz (1.8 V ≤ V<sub>DD</sub> ≤ 5.5 V)LV (low-voltage main) mode: 4 MHz (1.6 V ≤ V<sub>DD</sub> ≤ 5.5 V)**Caution** Select the TTL input buffer for the RxDq pin and the N-ch open drain output (V<sub>DD</sub> tolerance (for the 30- to 52-pin products)/EV<sub>D0</sub> tolerance (for the 64- to 100-pin products)) mode for the TxDq pin by using port input mode register g (PIMg) and port output mode register g (POMg). For V<sub>IH</sub> and V<sub>IL</sub>, see the DC characteristics with TTL input buffer selected.**Remark 1.** V<sub>b</sub> [V]: Communication line voltage**Remark 2.** q: UART number (q = 0 to 3), g: PIM and POM number (g = 0, 1, 5, 14)**Remark 3.** f<sub>MCK</sub>: Serial array unit operation clock frequency

(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13)

**Remark 4.** UART2 cannot communicate at different potential when bit 1 (PIOR01) of peripheral I/O redirection register 0 (PIOR0) is 1.

## 2.5.2 Serial interface IICA

### (1) I<sup>2</sup>C standard mode

(TA = -40 to +85°C, 1.6 V ≤ EV<sub>D0</sub> = EV<sub>D1</sub> ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>S0</sub> = EV<sub>S1</sub> = 0 V)

Parameter	Symbol	Conditions	HS (high-speed main) mode		LS (low-speed main) mode		LV (low-voltage main) mode		Unit	
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
SCLA0 clock frequency	f <sub>SCL</sub>	Standard mode: f <sub>CLK</sub> ≥ 1 MHz	2.7 V ≤ EV <sub>D0</sub> ≤ 5.5 V	0	100	0	100	0	100	kHz
			1.8 V ≤ EV <sub>D0</sub> ≤ 5.5 V	0	100	0	100	0	100	kHz
			1.7 V ≤ EV <sub>D0</sub> ≤ 5.5 V	0	100	0	100	0	100	kHz
			1.6 V ≤ EV <sub>D0</sub> ≤ 5.5 V	—		0	100	0	100	kHz
Setup time of restart condition	t <sub>SU: STA</sub>	2.7 V ≤ EV <sub>D0</sub> ≤ 5.5 V	4.7	4.7		4.7		4.7		μs
		1.8 V ≤ EV <sub>D0</sub> ≤ 5.5 V	4.7	4.7		4.7		4.7		μs
		1.7 V ≤ EV <sub>D0</sub> ≤ 5.5 V	4.7	4.7		4.7		4.7		μs
		1.6 V ≤ EV <sub>D0</sub> ≤ 5.5 V	—		4.7	4.7		4.7		μs
Hold time Note 1	t <sub>HD: STA</sub>	2.7 V ≤ EV <sub>D0</sub> ≤ 5.5 V	4.0	4.0		4.0		4.0		μs
		1.8 V ≤ EV <sub>D0</sub> ≤ 5.5 V	4.0	4.0		4.0		4.0		μs
		1.7 V ≤ EV <sub>D0</sub> ≤ 5.5 V	4.0	4.0		4.0		4.0		μs
		1.6 V ≤ EV <sub>D0</sub> ≤ 5.5 V	—		4.0	4.0		4.0		μs
Hold time when SCLA0 = "L"	t <sub>LOW</sub>	2.7 V ≤ EV <sub>D0</sub> ≤ 5.5 V	4.7	4.7		4.7		4.7		μs
		1.8 V ≤ EV <sub>D0</sub> ≤ 5.5 V	4.7	4.7		4.7		4.7		μs
		1.7 V ≤ EV <sub>D0</sub> ≤ 5.5 V	4.7	4.7		4.7		4.7		μs
		1.6 V ≤ EV <sub>D0</sub> ≤ 5.5 V	—		4.7	4.7		4.7		μs
Hold time when SCLA0 = "H"	t <sub>HIGH</sub>	2.7 V ≤ EV <sub>D0</sub> ≤ 5.5 V	4.0	4.0		4.0		4.0		μs
		1.8 V ≤ EV <sub>D0</sub> ≤ 5.5 V	4.0	4.0		4.0		4.0		μs
		1.7 V ≤ EV <sub>D0</sub> ≤ 5.5 V	4.0	4.0		4.0		4.0		μs
		1.6 V ≤ EV <sub>D0</sub> ≤ 5.5 V	—		4.0	4.0		4.0		μs

(Notes, Caution, and Remark are listed on the next page.)

## 2.6.6 LVD circuit characteristics

### (1) Reset Mode and Interrupt Mode

(TA = -40 to +85°C, VPDR ≤ VDD ≤ 5.5 V, Vss = 0 V)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Voltage detection threshold	Supply voltage level	VLVD0	Rising edge	3.98	4.06	4.14	V	
			Falling edge	3.90	3.98	4.06	V	
		VLVD1	Rising edge	3.68	3.75	3.82	V	
			Falling edge	3.60	3.67	3.74	V	
		VLVD2	Rising edge	3.07	3.13	3.19	V	
			Falling edge	3.00	3.06	3.12	V	
		VLVD3	Rising edge	2.96	3.02	3.08	V	
			Falling edge	2.90	2.96	3.02	V	
		VLVD4	Rising edge	2.86	2.92	2.97	V	
			Falling edge	2.80	2.86	2.91	V	
		VLVD5	Rising edge	2.76	2.81	2.87	V	
			Falling edge	2.70	2.75	2.81	V	
		VLVD6	Rising edge	2.66	2.71	2.76	V	
			Falling edge	2.60	2.65	2.70	V	
		VLVD7	Rising edge	2.56	2.61	2.66	V	
			Falling edge	2.50	2.55	2.60	V	
		VLVD8	Rising edge	2.45	2.50	2.55	V	
			Falling edge	2.40	2.45	2.50	V	
		VLVD9	Rising edge	2.05	2.09	2.13	V	
			Falling edge	2.00	2.04	2.08	V	
		VLVD10	Rising edge	1.94	1.98	2.02	V	
			Falling edge	1.90	1.94	1.98	V	
		VLVD11	Rising edge	1.84	1.88	1.91	V	
			Falling edge	1.80	1.84	1.87	V	
		VLVD12	Rising edge	1.74	1.77	1.81	V	
			Falling edge	1.70	1.73	1.77	V	
		VLVD13	Rising edge	1.64	1.67	1.70	V	
			Falling edge	1.60	1.63	1.66	V	
Minimum pulse width		tLW		300			μs	
Detection delay time						300	μs	

### 3.1 Absolute Maximum Ratings

**Absolute Maximum Ratings** (1/2)

Parameter	Symbols	Conditions	Ratings	Unit
Supply voltage	V <sub>DD</sub>		-0.5 to +6.5	V
	EV <sub>DD0</sub> , EV <sub>DD1</sub>	EV <sub>DD0</sub> = EV <sub>DD1</sub>	-0.5 to +6.5	V
	EV <sub>SS0</sub> , EV <sub>SS1</sub>	EV <sub>SS0</sub> = EV <sub>SS1</sub>	-0.5 to +0.3	V
REGC pin input voltage	V <sub>IREGC</sub>	REGC	-0.3 to +2.8 and -0.3 to V <sub>DD</sub> +0.3 Note 1	V
Input voltage	V <sub>I1</sub>	P00 to P06, P10 to P17, P30, P31, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P100 to P102, P110, P111, P120, P140 to P147	-0.3 to EV <sub>DD0</sub> +0.3 and -0.3 to V <sub>DD</sub> +0.3 Note 2	V
	V <sub>I2</sub>	P60 to P63 (N-ch open-drain)	-0.3 to +6.5	V
	V <sub>I3</sub>	P20 to P27, P121 to P124, P137, P150 to P156, EXCLK, EXCLKS, <u>RESET</u>	-0.3 to V <sub>DD</sub> +0.3 Note 2	V
Output voltage	V <sub>O1</sub>	P00 to P06, P10 to P17, P30, P31, P40 to P47, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P100 to P102, P110, P111, P120, P130, P140 to P147	-0.3 to EV <sub>DD0</sub> +0.3 and -0.3 to V <sub>DD</sub> +0.3 Note 2	V
	V <sub>O2</sub>	P20 to P27, P150 to P156	-0.3 to V <sub>DD</sub> +0.3 Note 2	V
Analog input voltage	V <sub>AI1</sub>	ANI16 to ANI20	-0.3 to EV <sub>DD0</sub> +0.3 and -0.3 to AV <sub>REF</sub> (+) +0.3 Notes 2, 3	V
	V <sub>AI2</sub>	ANI0 to ANI14	-0.3 to V <sub>DD</sub> +0.3 and -0.3 to AV <sub>REF</sub> (+) +0.3 Notes 2, 3	V

**Note 1.** Connect the REGC pin to Vss via a capacitor (0.47 to 1  $\mu$ F). This value regulates the absolute maximum rating of the REGC pin. Do not use this pin with voltage applied to it.

**Note 2.** Must be 6.5 V or lower.

**Note 3.** Do not exceed AV<sub>REF</sub>(+) + 0.3 V in case of A/D conversion target pin.

**Caution** Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

**Remark 1.** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

**Remark 2.** AV<sub>REF</sub>(+): + side reference voltage of the A/D converter.

**Remark 3.** V<sub>SS</sub>: Reference voltage

- Note 1.** Total current flowing into V<sub>DD</sub>, EV<sub>DD0</sub>, and EV<sub>DD1</sub>, including the input leakage current flowing when the level of the input pin is fixed to V<sub>DD</sub>, EV<sub>DD0</sub>, and EV<sub>DD1</sub>, or V<sub>SS</sub>, EV<sub>VSS0</sub>, and EV<sub>VSS1</sub>. The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, D/A converter, comparator, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.
- Note 2.** During HALT instruction execution by flash memory.
- Note 3.** When high-speed on-chip oscillator and subsystem clock are stopped.
- Note 4.** When high-speed system clock and subsystem clock are stopped.
- Note 5.** When high-speed on-chip oscillator and high-speed system clock are stopped. When RTCLPC = 1 and setting ultra-low current consumption (AMPHS1 = 1). The current flowing into the RTC is included. However, not including the current flowing into the 12-bit interval timer and watchdog timer.
- Note 6.** Not including the current flowing into the RTC, 12-bit interval timer, and watchdog timer.
- Note 7.** Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.  
HS (high-speed main) mode: 2.7 V ≤ V<sub>DD</sub> ≤ 5.5 V @ 1 MHz to 32 MHz  
2.4 V ≤ V<sub>DD</sub> ≤ 5.5 V @ 1 MHz to 16 MHz
- Note 8.** Regarding the value for current to operate the subsystem clock in STOP mode, refer to that in HALT mode.

**Remark 1.** f<sub>MX</sub>: High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)

**Remark 2.** f<sub>HOCO</sub>: High-speed on-chip oscillator clock frequency (64 MHz max.)

**Remark 3.** f<sub>IH</sub>: High-speed on-chip oscillator clock frequency (32 MHz max.)

**Remark 4.** f<sub>SUB</sub>: Subsystem clock frequency (XT1 clock oscillation frequency)

**Remark 5.** Except subsystem clock operation and STOP mode, temperature condition of the TYP. value is TA = 25°C

### 3.4 AC Characteristics

(TA = -40 to +105°C, 2.4 V ≤ EV<sub>DD0</sub> = EV<sub>DD1</sub> ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>SS0</sub> = EV<sub>SS1</sub> = 0 V)

Items	Symbol	Conditions			MIN.	TYP.	MAX.	Unit
Instruction cycle (minimum instruction execution time)	T <sub>CV</sub>	Main system clock (f <sub>MAIN</sub> ) operation	HS (high-speed main) mode	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V	0.03125		1	μs
				2.4 V ≤ V <sub>DD</sub> < 2.7 V	0.0625		1	μs
		Subsystem clock (f <sub>SUB</sub> ) operation		2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V	28.5	30.5	31.3	μs
		In the self-programming mode	HS (high-speed main) mode	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V	0.03125		1	μs
External system clock frequency	f <sub>EX</sub>	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V			1.0		20.0	MHz
		2.4 V ≤ V <sub>DD</sub> ≤ 2.7 V			1.0		16.0	MHz
	f <sub>EXS</sub>				32		35	kHz
External system clock input high-level width, low-level width	t <sub>EXH</sub> , t <sub>EXL</sub>	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V			24			ns
		2.4 V ≤ V <sub>DD</sub> ≤ 2.7 V			30			ns
	t <sub>EXHS</sub> , t <sub>EXLS</sub>				13.7			μs
TI00 to TI03, TI10 to TI13 input high-level width, low-level width	t <sub>TIH</sub> , t <sub>TIL</sub>				1/f <sub>MCK</sub> + 10 Note			ns
Timer RJ input cycle	f <sub>C</sub>	TRJIO	2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		100			ns
			2.4 V ≤ EV <sub>DD0</sub> < 2.7 V		300			ns
Timer RJ input high-level width, low-level width	t <sub>TJH</sub> , t <sub>TJL</sub>	TRJIO	2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		40			ns
			2.4 V ≤ EV <sub>DD0</sub> < 2.7 V		120			ns

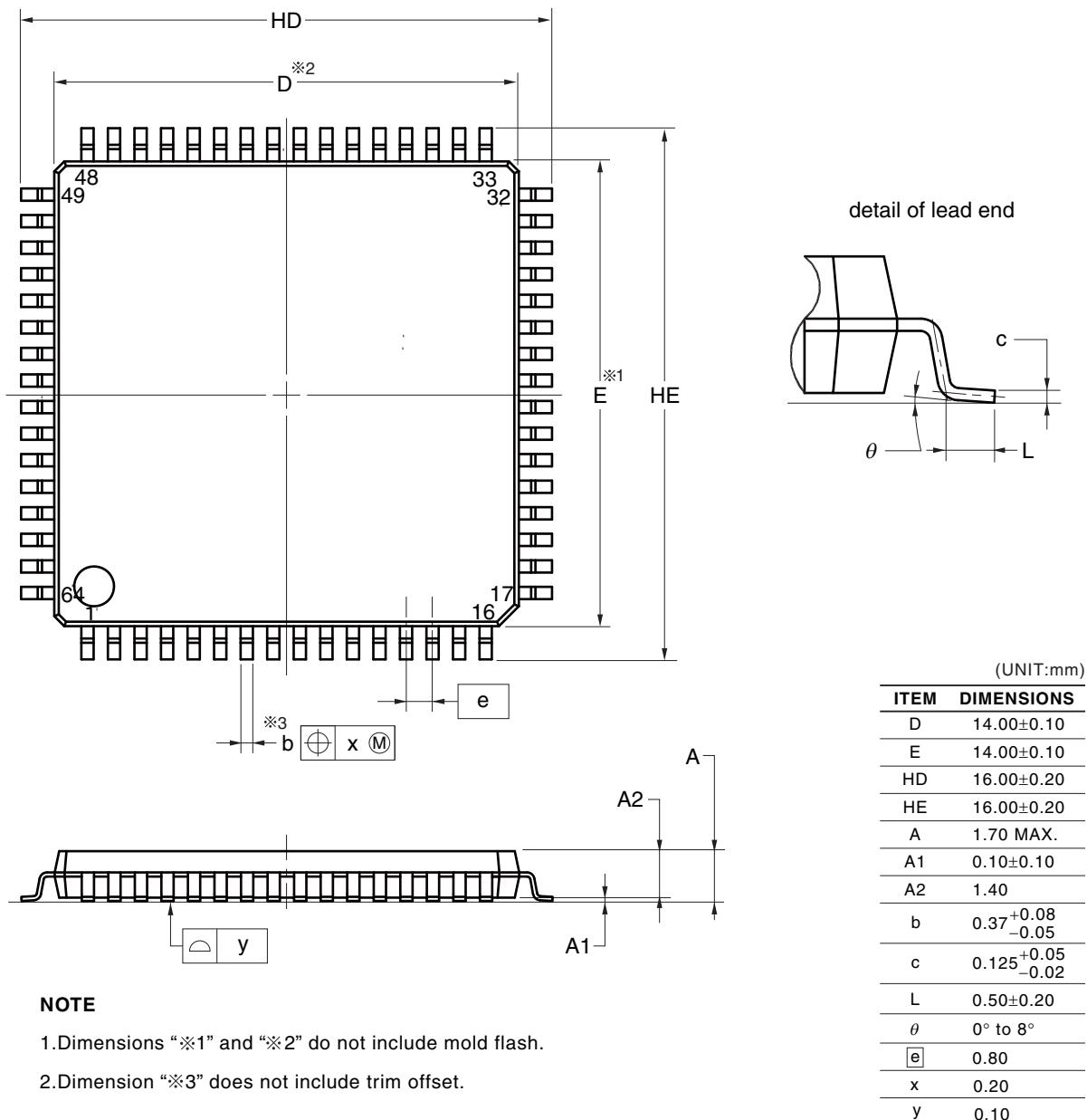
**Note** The following conditions are required for low voltage interface when EV<sub>DD0</sub> < V<sub>DD</sub>  
2.4 V ≤ EV<sub>DD0</sub> < 2.7 V: MIN. 125 ns

**Remark** f<sub>MCK</sub>: Timer array unit operation clock frequency

(Operation clock to be set by the CKSmn bit of timer mode register mn (TMRmn). m: Unit number (m = 0, 1), n: Channel number (n = 0 to 3))

R5F104LCAFP, R5F104LDAFP, R5F104LEAFP, R5F104LFAFP, R5F104LG AFP, R5F104LHAFP, R5F104LJ AFP  
 R5F104LCDFP, R5F104LDDFP, R5F104LEDFP, R5F104LFDFP, R5F104LGDFP, R5F104LHD FP, R5F104LJD FP  
 R5F104LCGFP, R5F104LDGFP, R5F104LEGFP, R5F104LFGFP, R5F104LGGFP, R5F104LHGFP, R5F104LJGFP

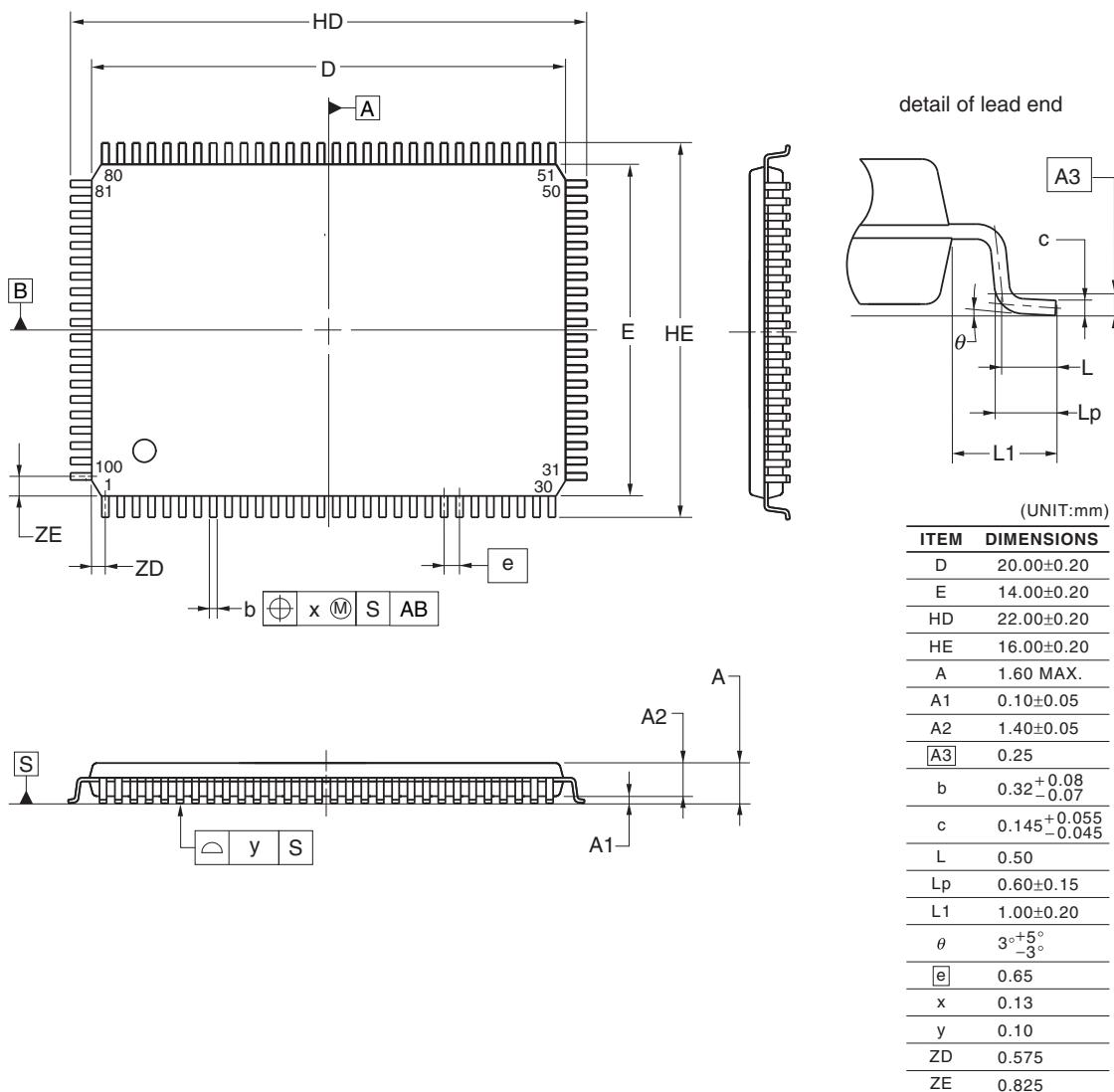
JEITA Package Code	RENESAS Code	Previous Code	MASS (TYP.) [g]
P-LQFP64-14x14-0.80	PLQP0064GA-A	P64GC-80-GBW-1	0.7



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R5F104PFAFA, R5F104PGAFA, R5F104PHAFA, R5F104PJFAFA  
 R5F104PFDFA, R5F104PGDFA, R5F104PHDFA, R5F104PJDFA  
 R5F104PFGFA, R5F104PGGFA, R5F104PHGFA, R5F104PJGFA  
 R5F104PKAFA, R5F104PLAFA  
 R5F104PKGFA, R5F104PLGFA

JEITA Package Code	RENESAS Code	Previous Code	MASS (TYP.) [g]
P-LQFP100-14x20-0.65	PLQP0100JC-A	P100GF-65-GBN-1	0.92



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